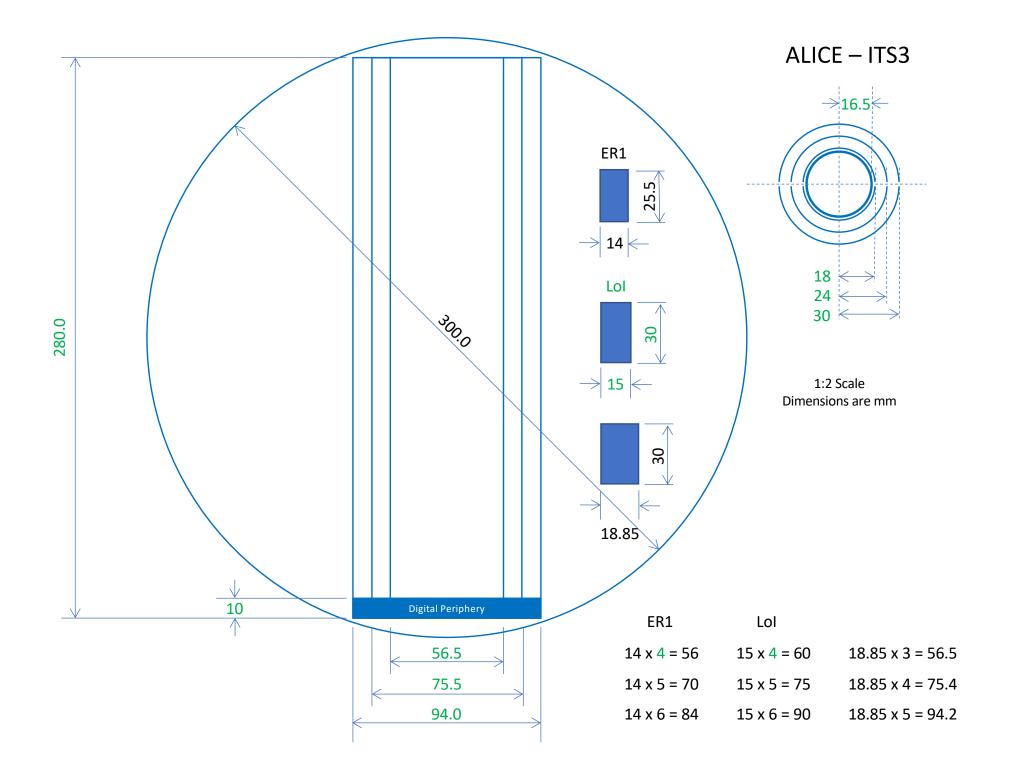
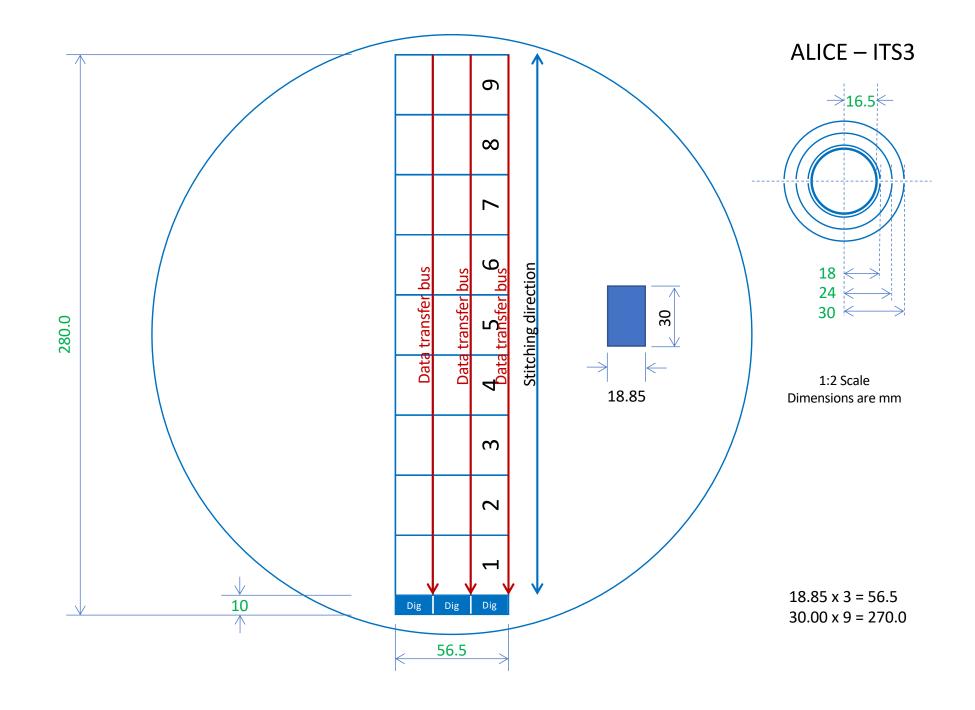
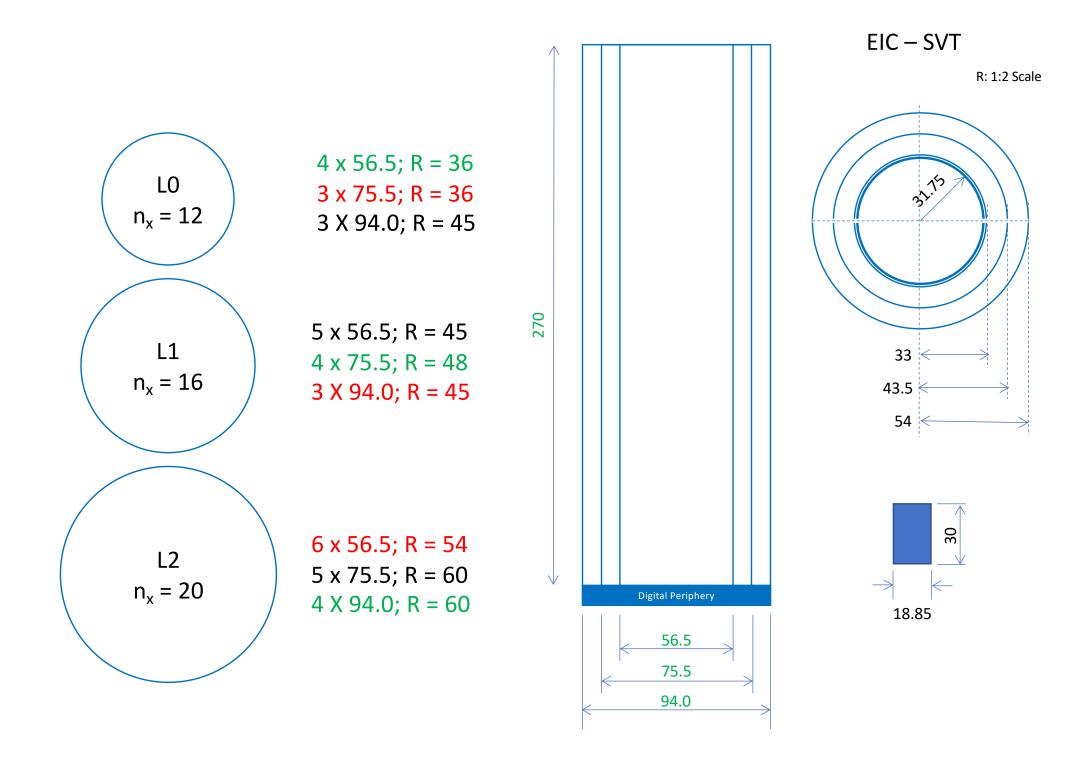
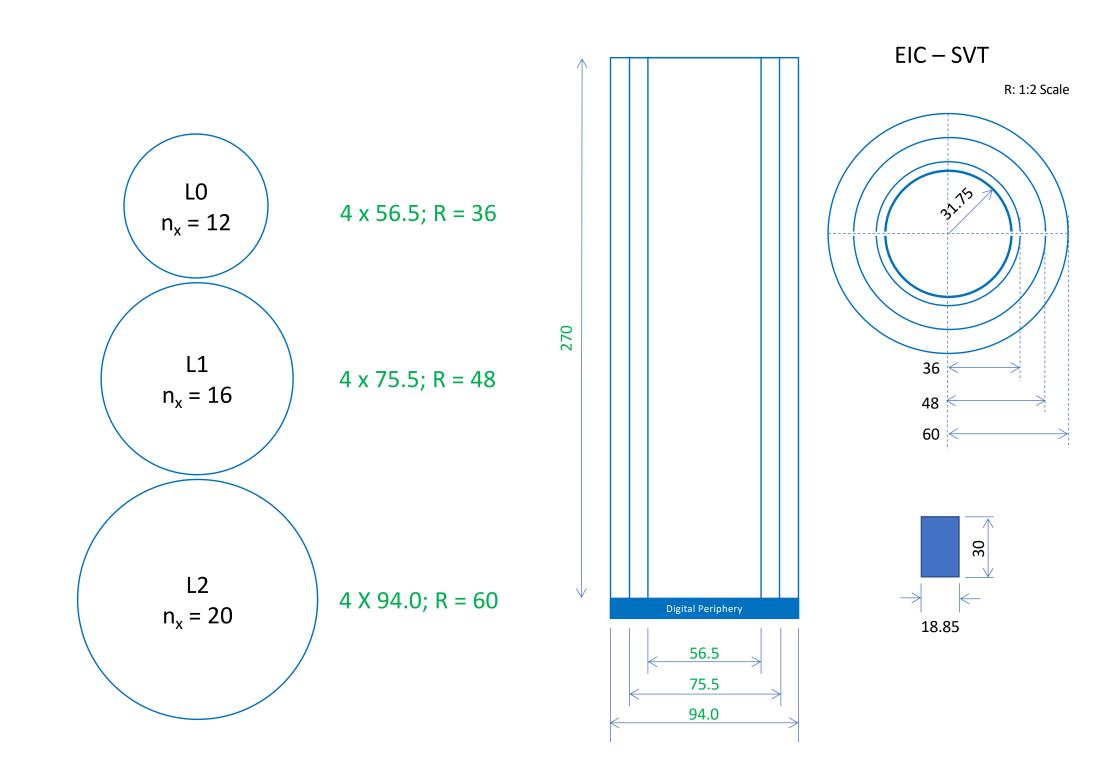
EIC Sensors – Vertex and Barrel

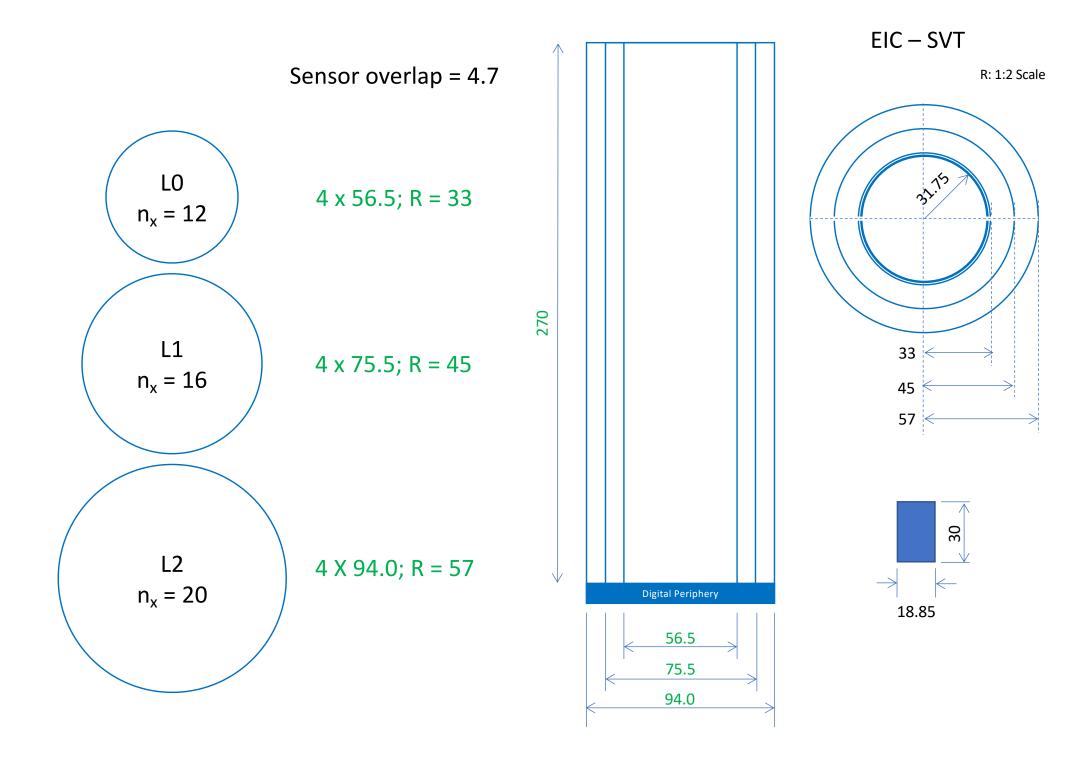
- ALICE ITS3 Sensors
 - Update on reticle size
- EIC Vertex Layers
 - Using ITS3 sensors
 - Option for EIC-specific sensors
- EIC Barrel Layers
 - Options for sensors maximising use of wafer
 - Implication for barrel layers
 - Proposed layout for the barrel layers

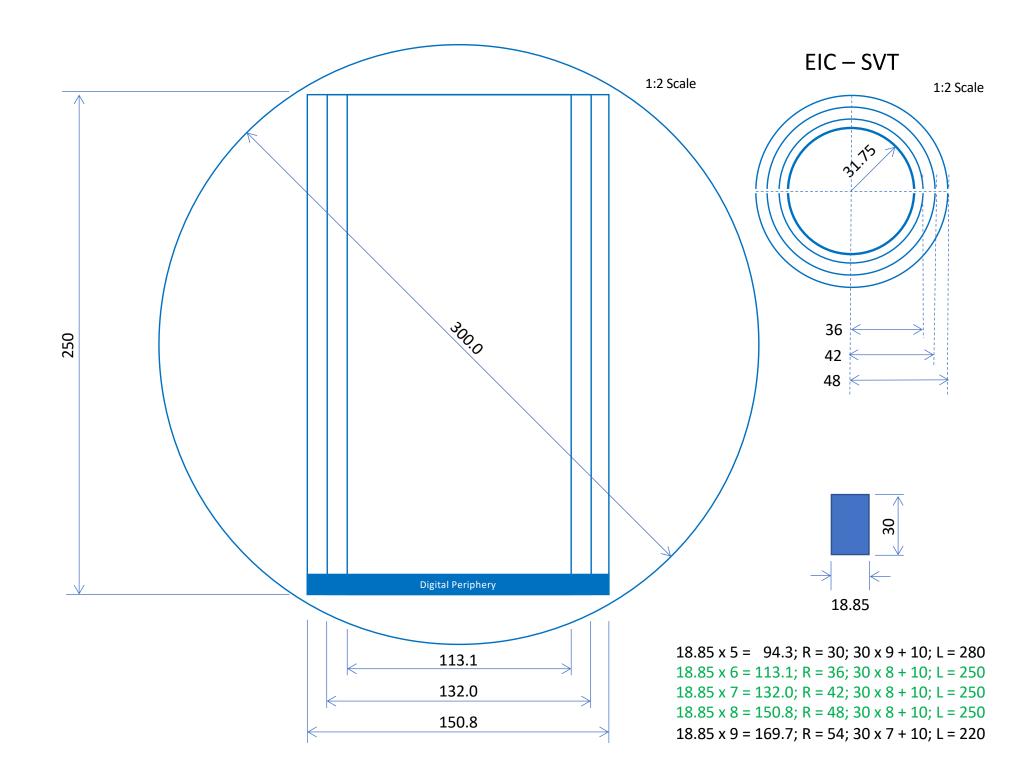




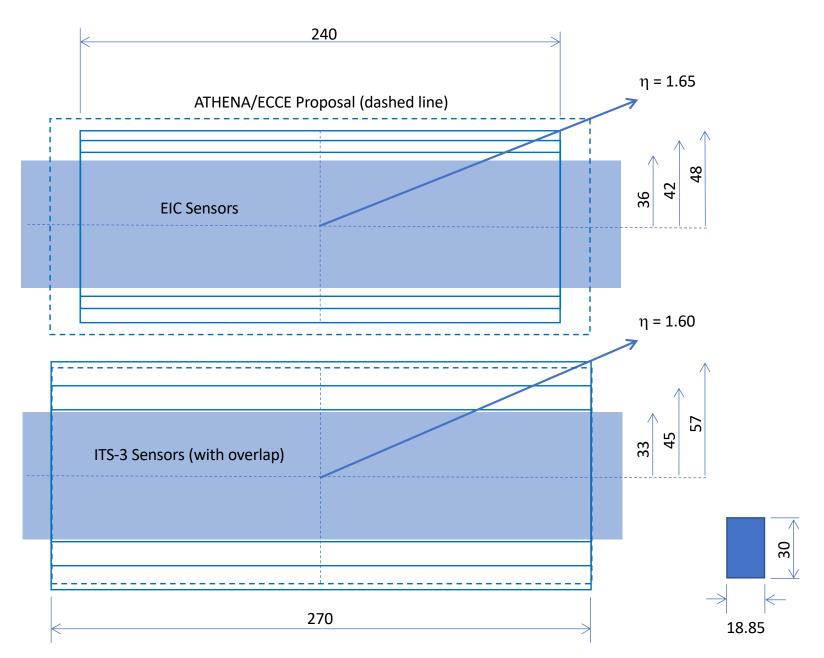


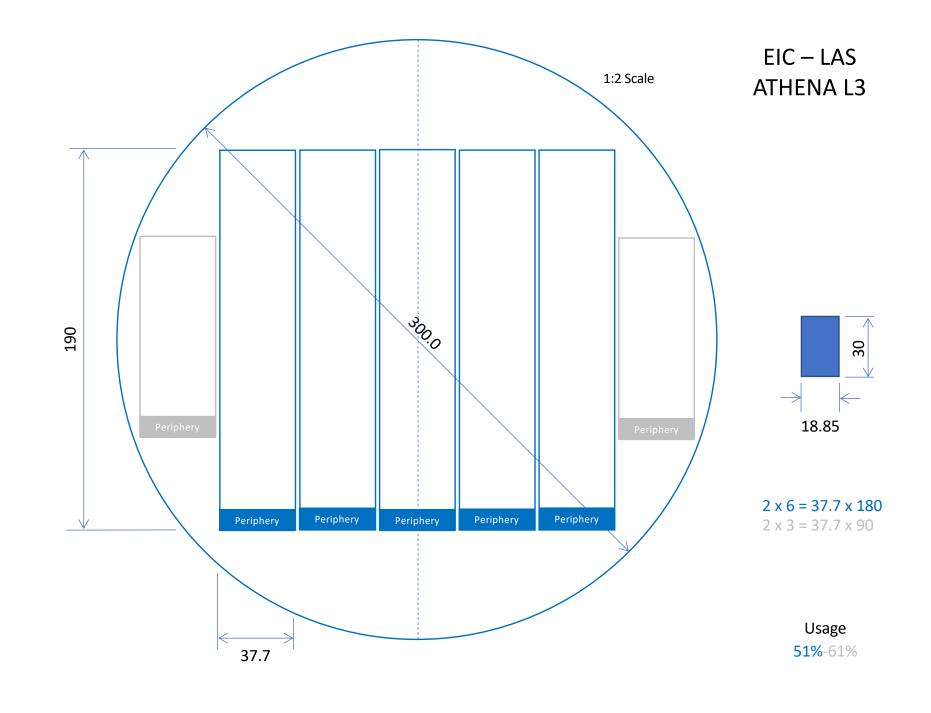


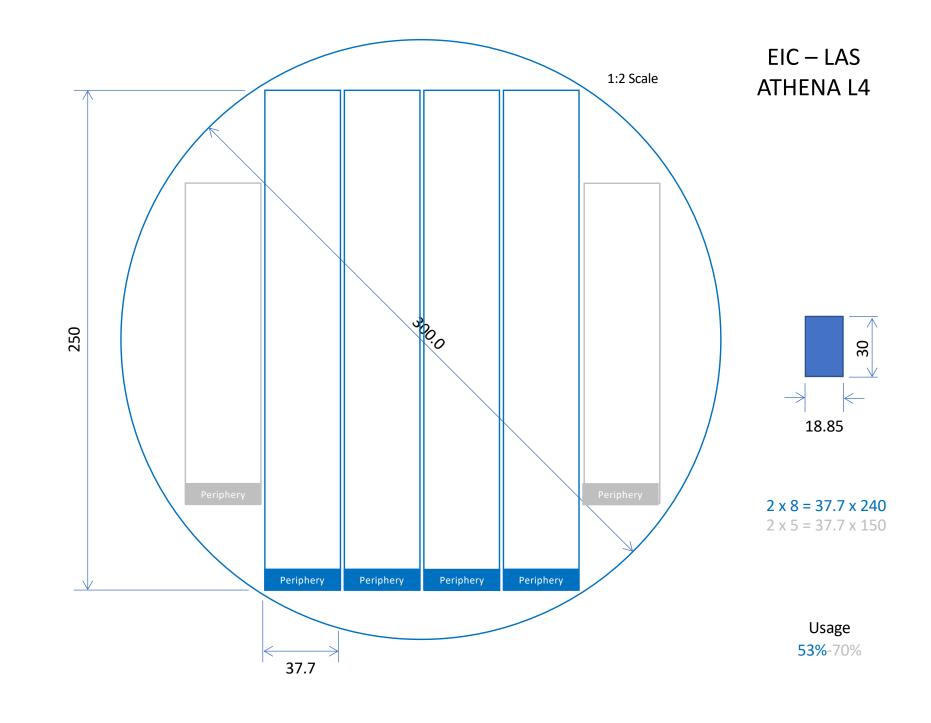




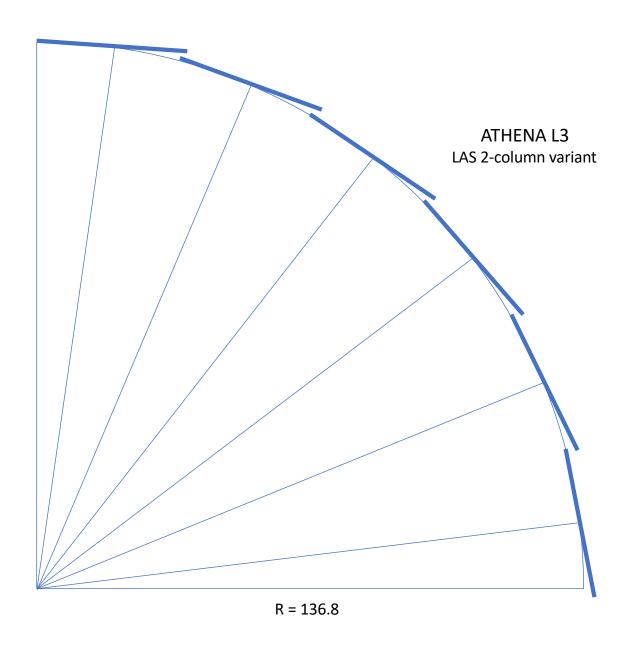
1:2 Scale







EIC – LAS



ATHENA L3

Target radius R = 133.4 Final radius R = 136.8 LAS form factor = 2 x 6 LAS per quadrant = 6 Tilt angle = 4 degrees

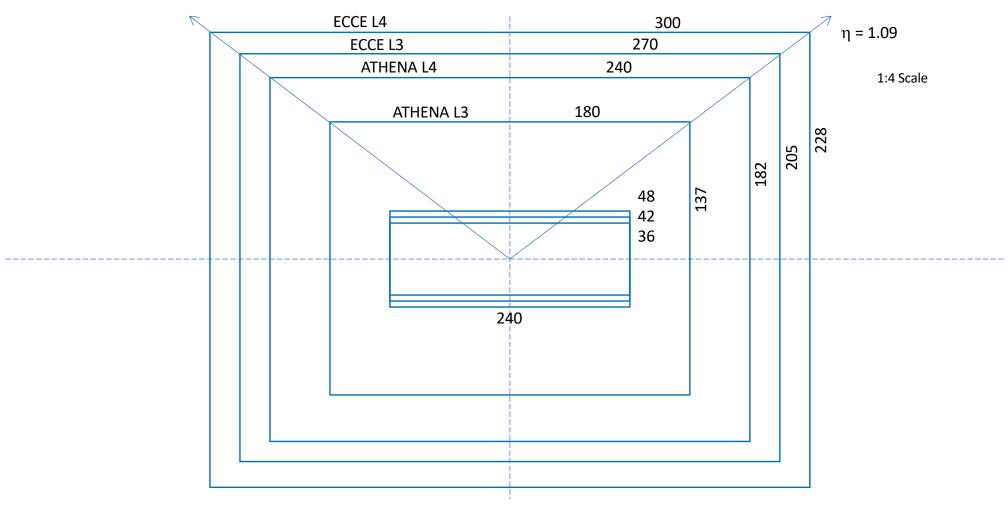
ATHENA L4

Target radius R = 179.6 Final radius R = 182.1 LAS form factor = 2 x 8 LAS per quadrant = 8 Tilt angle = 3 degrees

ECCE L3

Target radius R = 210.0 LAS form factor = 5 x 9 LAS per quadrant = 3.5 Final radius R = 204.8 LAS form factor = 2 x 9 LAS per quadrant = 9 Tilt angle = 2.5 degrees

ECCE L4 See next slide



Note: radii and lengths adjusted slightly to work with reticle size 18.85 x 30.00 mm²

Length of vertex layers is made of one sensor read out at ONE end

Length of barrel layers is made of two sensors read out at BOTH ends

ATHENA L3 = 2 x 6 reticles (5 per wafer; usage = 51%; 48 LAS required; 10 wafers)

ATHENA L4 = 2 x 8 reticles (4 per wafer; usage = 53%; 64 LAS required; 16 wafers)

ECCE L3 = 2 x 9 reticles (2 per wafer; usage = 30%; 72 LAS required; 36 wafers)

ECCE L3 = 5 x 9 reticles (1 per wafer; usage = 37%; 32 LAS required; 32 wafers)

ECCE L4 = Length not achievable with two single-wafer sensors

Summary

- ALICE ITS3 sensors
 - Ideal reticle size for ITS3 is 18.85 x 30 mm²
 - Likely to change (increase) to create some sensor overlap
 - EIC will use same reticle size as ITS3
 - We do not have the resources to redesign the "unit cell" containing the pixel matrix; this would lead to a significant increase in development time and cost
- EIC sensors for vertex and barrel layers
 - Options to vary number of "unit cells" per sensor
 - Has implications for the radii, length, material budget and cost
 - ECCE outer barrel layers requires more than two sensors; implying services must run along stave for the third sensor
 - Factor in estimates for the yield into the number of wafers needed
 - Starting to think about mechanical design